Atty Dkt. No.: LIFE-072DIV USSN: 10/052,447

AMENDMENTS TO THE CLAIMS:

1.- 21. (Cancelled)

22. (Previously Presented) A method for manufacturing a fluidic diagnostic device comprising the steps of:

placing a double-sided adhesive tape between a first and a second release liner;

cutting out a portion of the first release liner and tape to form a pattern, the pattern comprising a sample port, a measurement area, a channel having a first end and a second end to provide a fluidic path from the sample port at the first end through the measurement area, and a bladder;

removing the second release liner from the double-sided tape;

laminating a hydrophilic polyester film to the pattern;

printing a reagent onto the measurement area;

cutting a sample port through an untreated polyester film;

removing the first release layer from the double-sided tape;

laminating the untreated polyester film to the double side tape;

cutting a stop junction through the untreated polyester film, the tape and the hydrophilic polyester film; and

applying one or more single-sided adhesive tape strips to the periphery of the hydrophilic and untreated polyester films to seal the stop junction.

- 23. (Previously Presented) The method of claim 22, wherein the pattern further comprises a bypass channel.
- 24. (Currently Amended) A method for manufacturing a fluidic diagnostic device, the method comprising the steps of:

die cutting a first layer having at least one opening therethrough;

molding a second layer and a third layer, the third layer having a pattern therein, the pattern comprising cutouts for a sample port, a measurement area, a channel having a first end and a second end to provide a fluidic path from the sample port at the first end through the measurement area, and a bladder;

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placing the third layer between the first and the second layer, wherein a portion of at least one of the first layer and the second layer adjacent the bladder cutout of the third layer is configured to be resilient; and welding the layers together at the periphery to from form the device.

25. (Previously Presented) The method of claim 24, wherein the pattern further comprises a bypass channel.